

## 200mA Low-Noise, High-PSRR Negative Output Low-Dropout Linear Regulators

### FEATURES

- **Ultralow Noise:** 60 $\mu$ V<sub>RMS</sub> Typical
- **High PSRR:** 65dB Typical at 1kHz
- **Low Dropout Voltage:** 280mV Typical at 200mA, 2.5V
- **Available in –2.5V and Adjustable (–1.2V to –10V) Versions**
- **Stable With a 2.2 $\mu$ F Ceramic Output Capacitor**
- **Less Than 2 $\mu$ A Typical Quiescent Current in Shutdown Mode**
- **2% Overall Accuracy (Line, Load, Temperature)**
- **Thermal and Over-Current Protection**
- **SOT23-5 (DBV) Package**
- **Operating Junction Temperature Range:** –40°C to +125°C

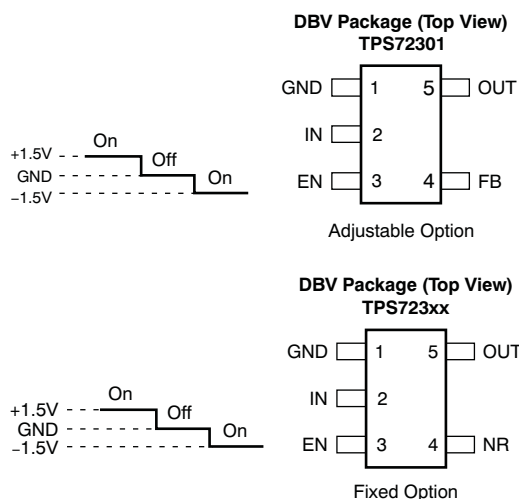
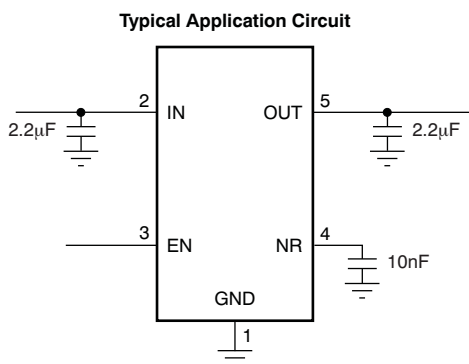
### APPLICATIONS

- Optical Drives
- Optical Networking
- Noise Sensitive Circuitry
- GaAs FET Gate Bias
- Video Amplifiers

### DESCRIPTION

The TPS723xx family of low-dropout (LDO) negative voltage regulators offers an ideal combination of features to support low noise applications. These devices are capable of operating with input voltages from –10V to –2.7V, and support outputs from –10V to –1.2V. These regulators are stable with small, low-cost ceramic capacitors, and include enable (EN) and noise reduction (NR) functions. Thermal short-circuit and over-current protections are provided by internal detection and shutdown logic. High PSRR (65dB at 1kHz) and low noise (60 $\mu$ V<sub>RMS</sub>) make the TPS723xx ideal for low-noise applications.

The TPS723xx uses a precision voltage reference to achieve 2% overall accuracy over load, line, and temperature variations. Available in a small SOT23-5 package, the TPS723xx family is fully specified over a temperature range of –40°C to +125°C.



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## ORDERING INFORMATION<sup>(1)</sup>

| PRODUCT    | V <sub>OUT</sub> <sup>(2)</sup>                                                                                                 |
|------------|---------------------------------------------------------------------------------------------------------------------------------|
| TPS723xyyz | XX is nominal output voltage (for example, 25 = 2.5V, 01 = Adjustable.)<br>YYY is package designator.<br>Z is package quantity. |

- (1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) Output voltages from –1.2V to –9V in 100mV increments are available. Minimum order quantities apply; contact factory for details and availability.

## ABSOLUTE MAXIMUM RATINGS<sup>(1)(2)</sup>

Over operating temperature range, unless otherwise noted.

|                                                    | VALUE                                               | UNITS |
|----------------------------------------------------|-----------------------------------------------------|-------|
| Input voltage range, V <sub>IN</sub>               | –11 to +0.3                                         | V     |
| Noise reduction pin voltage range, V <sub>NR</sub> | –11 to +5.5                                         | V     |
| Enable voltage range, V <sub>EN</sub>              | –V <sub>IN</sub> to +5.5                            | V     |
| Output voltage range, V <sub>OUT</sub>             | –11 to +0.3                                         | V     |
| Output current, I <sub>OUT</sub>                   | Internally limited                                  |       |
| Output short-circuit duration                      | Indefinite                                          |       |
| Continuous total power dissipation, P <sub>D</sub> | See <a href="#">Power Dissipation Ratings</a> table |       |
| Junction temperature range, T <sub>J</sub>         | –55 to +150                                         | °C    |
| Storage temperature range, T <sub>stg</sub>        | –65 to +150                                         | °C    |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to network ground terminal.

## POWER DISSIPATION RATINGS

| BOARD                 | PACKAGE | R <sub>θJC</sub> | R <sub>θJA</sub> | DERATING FACTOR<br>ABOVE T <sub>A</sub> = +25°C | T <sub>A</sub> ≤ +25°C<br>POWER<br>RATING | T <sub>A</sub> = +70°C<br>POWER<br>RATING | T <sub>A</sub> = +85°C<br>POWER<br>RATING |
|-----------------------|---------|------------------|------------------|-------------------------------------------------|-------------------------------------------|-------------------------------------------|-------------------------------------------|
| Low-K <sup>(1)</sup>  | DBV     | 64°C/W           | 255°C/W          | 3.9mW/°C                                        | 390mW                                     | 215mW                                     | 155mW                                     |
| High-K <sup>(2)</sup> | DBV     | 64°C/W           | 180°C/W          | 5.6mW/°C                                        | 560mW                                     | 310mW                                     | 225mW                                     |

- (1) The JEDEC Low-K (1s) board design used to derive this data was a 3 inch × 3 inch, two-layer board with 2-ounce copper traces on top of the board.
- (2) The JEDEC High-K (2s2p) board design used to derive this data was a 3 inch × 3 inch, multilayer board with 1-ounce internal power and ground planes and 2-ounce copper traces on the top and bottom of the board.

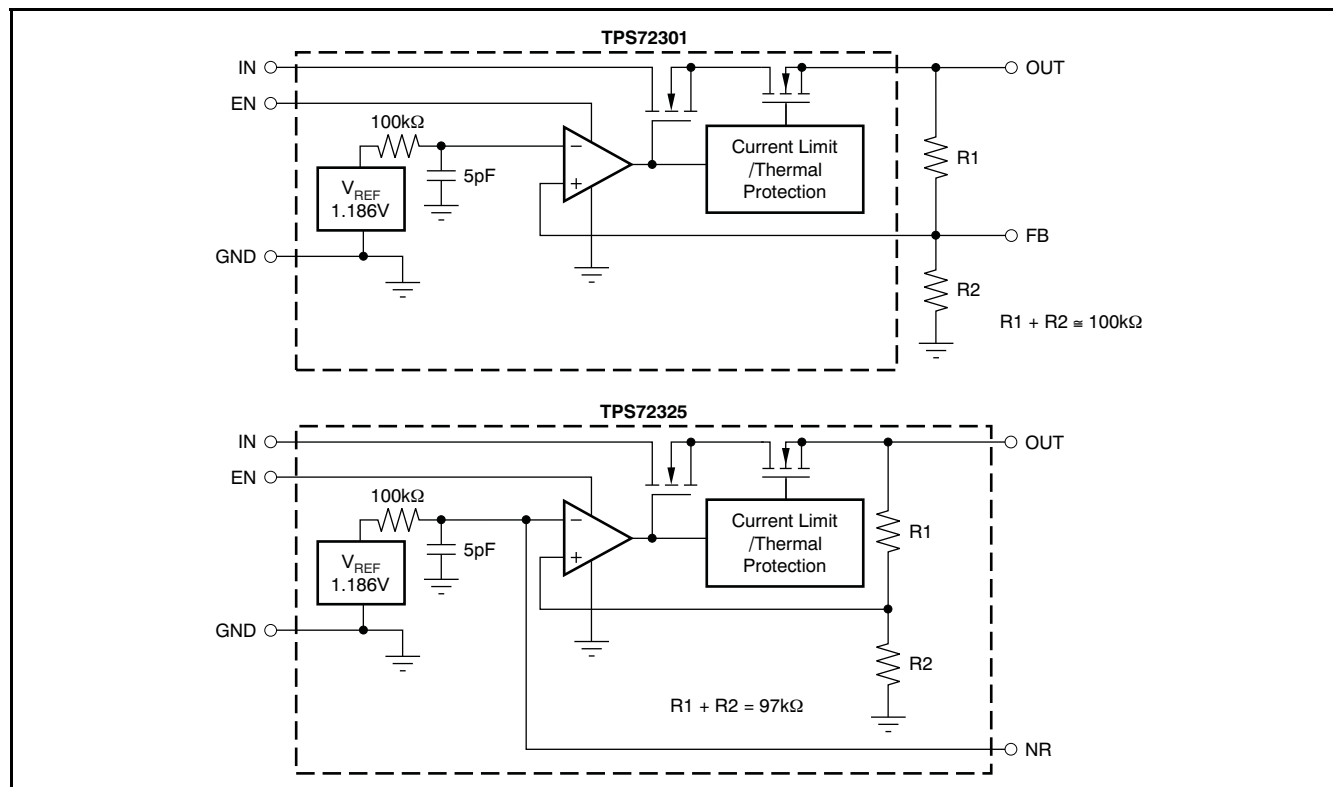
## ELECTRICAL CHARACTERISTICS

Over operating junction temperature range,  $V_{IN} = V_{OUT(nom)} - 0.5V$ ,  $I_{OUT} = 1mA$ ,  $V_{EN} = 1.5V$ ,  $C_{OUT} = 2.2\mu F$ , and  $C_{NR} = 0.01\mu F$ , unless otherwise noted. Typical values are at  $T_J = +25^\circ C$ .

| PARAMETER         |                                                         |                                | TEST CONDITIONS                                                               | TPS723xx       |         |          | UNITS         |
|-------------------|---------------------------------------------------------|--------------------------------|-------------------------------------------------------------------------------|----------------|---------|----------|---------------|
|                   |                                                         |                                |                                                                               | MIN            | TYP     | MAX      |               |
| $V_{IN}$          | Input voltage range <sup>(1)</sup>                      |                                |                                                                               | -10            |         | -2.7     | V             |
| $V_{FB}$          | Feedback reference voltage                              | TPS72301                       | $T_J = +25^\circ C$                                                           | -1.210         | -1.186  | -1.162   | V             |
| $V_{OUT}$         | Output voltage range                                    | TPS72301                       |                                                                               | $-10 + V_{DO}$ |         | $V_{FB}$ | V             |
|                   | Accuracy                                                | Nominal                        | $T_J = +25^\circ C$                                                           | -1             |         | 1        | %             |
|                   |                                                         | TPS72325 vs $V_{IN}/I_{OUT}/T$ | $-10V \leq V_{IN} \leq V_{OUT} - 0.5V$ ,<br>$10\mu A \leq I_{OUT} \leq 200mA$ | -2             | $\pm 1$ | 2        | %             |
|                   |                                                         | TPS72301 vs $V_{IN}/I_{OUT}/T$ |                                                                               | -3             | $\pm 1$ | 3        | %             |
| $V_{OUT}/V_{IN}$  | Line regulation                                         |                                | $-10V \leq V_{IN} \leq V_{OUT(nom)} - 0.5V$                                   |                | 0.04    |          | %/V           |
| $V_{OUT}/I_{OUT}$ | Load regulation                                         |                                | $0mA \leq I_{OUT} \leq 200mA$                                                 |                | 0.002   |          | %/mA          |
| $V_{DO}$          | Dropout voltage at $V_{OUT} = 0.96 \times V_{OUT(nom)}$ | TPS72325                       | $I_{OUT} = 200mA$                                                             |                | 280     | 500      | mV            |
| $I_{CL}$          | Current limit                                           |                                | $V_{OUT} = 0.85 \times V_{OUT(nom)}$                                          | 300            | 550     | 800      | mA            |
| $I_{GND}$         | Ground pin current                                      |                                | $I_{OUT} = 0mA (I_Q)$ ,<br>$-10V \leq V_{IN} \leq V_{OUT} - 0.5V$             |                | 130     | 200      | $\mu A$       |
|                   |                                                         |                                | $I_{OUT} = 200mA$ ,<br>$-10V \leq V_{IN} \leq V_{OUT} - 0.5V$                 |                | 350     | 500      |               |
| $I_{SHDN}$        | Shutdown ground pin current                             |                                | $-0.4V \leq V_{EN} \leq 0.4V$ ,<br>$-10V \leq V_{IN} \leq V_{OUT} - 0.5V$     |                | 0.1     | 2.0      | $\mu A$       |
| $I_{FB}$          | Feedback pin current                                    |                                | $-10V \leq V_{IN} \leq V_{OUT} - 0.5V$                                        |                | 0.05    | 1.0      | $\mu A$       |
| PSRR              | Power-supply rejection ratio                            | TPS72325                       | $I_{OUT} = 200mA$ , 1kHz,<br>$C_{IN} = C_{OUT} = 10\mu F$                     |                | 65      |          | dB            |
|                   |                                                         |                                | $I_{OUT} = 200mA$ , 10kHz,<br>$C_{IN} = C_{OUT} = 10\mu F$                    |                | 48      |          |               |
| $V_n$             | Output noise voltage                                    | TPS72325                       | $C_{OUT} = 10\mu F$ , 10Hz to 100kHz,<br>$I_{OUT} = 200mA$                    |                | 60      |          | $\mu V_{RMS}$ |
| $t_{STR}$         | Startup time                                            |                                | $V_{OUT} = -2.5V$ , $C_{OUT} = 1\mu F$ ,<br>$R_L = 25\Omega$                  |                | 1       |          | ms            |
| $V_{EN(HI)}$      | Enable threshold positive                               |                                |                                                                               | 1.5            |         |          | V             |
| $V_{EN(LO)}$      | Enable threshold negative                               |                                |                                                                               |                |         | -1.5     | V             |
| $V_{DIS(HI)}$     | Disable threshold positive                              |                                |                                                                               |                |         | 0.4      | V             |
| $V_{DIS(LO)}$     | Disable threshold negative                              |                                |                                                                               | -0.4           |         |          | V             |
| $I_{EN}$          | Enable pin current                                      |                                | $-10V \leq V_{IN} \leq V_{OUT} - 0.5V$ ,<br>$-10V \leq V_{EN} \leq \pm 3.5V$  |                | 0.1     | 2.0      | $\mu A$       |
| $T_{SD}$          | Thermal shutdown temperature                            |                                | Shutdown, temperature increasing                                              |                | +165    |          | $^\circ C$    |
|                   |                                                         |                                | Reset, temperature decreasing                                                 |                | +145    |          |               |
| $T_J$             | Operating junction temperature                          |                                |                                                                               | -40            |         | +125     | $^\circ C$    |

(1) Maximum  $V_{IN} = (V_{OUT} - V_{DO})$  or  $-2.7V$ , whichever is more negative.

## FUNCTIONAL BLOCK DIAGRAM



## TERMINAL FUNCTIONS

| TERMINAL |     | DESCRIPTION                                                                                                                                                                                                                                                                   |
|----------|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME     | NO. |                                                                                                                                                                                                                                                                               |
| GND      | 1   | Ground                                                                                                                                                                                                                                                                        |
| IN       | 2   | Input supply                                                                                                                                                                                                                                                                  |
| EN       | 3   | Bipolar enable pin. Driving this pin above the positive enable threshold or below the negative enable threshold turns on the regulator. Driving this pin below the positive disable threshold and above the negative disable threshold puts the regulator into shutdown mode. |
| NR       | 4   | Fixed voltage versions only. Connecting an external capacitor between this pin and ground, bypasses noise generated by the internal bandgap. This configuration allows output noise to be reduced to very low levels.                                                         |
| FB       | 4   | Adjustable voltage version only. This pin is the input to the control loop error amplifier. It is used to set the output voltage of the device.                                                                                                                               |
| OUT      | 5   | Regulated output voltage. A small 2.2 $\mu$ F ceramic capacitor is needed from this pin to GND to ensure stability.                                                                                                                                                           |

## TYPICAL CHARACTERISTICS

TPS72325 at  $V_{IN} = V_{OUTnom} - 0.5V$ ,  $I_{OUT} = 1mA$ ,  $V_{EN} = 1.5V$ ,  $C_{OUT} = 2.2\mu F$ , and  $C_{NR} = 0.01\mu F$ , unless otherwise noted.

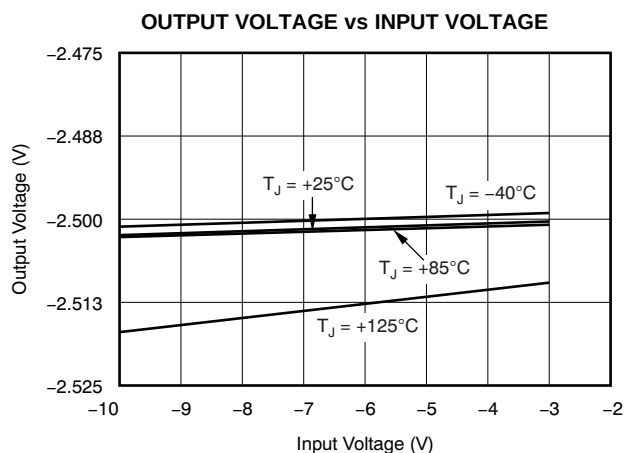


Figure 1.

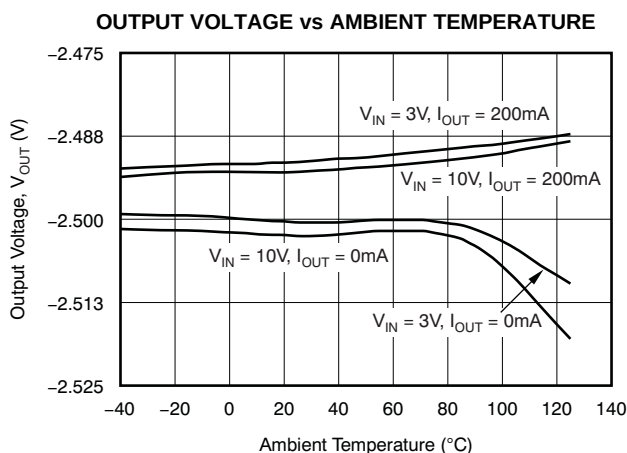


Figure 2.

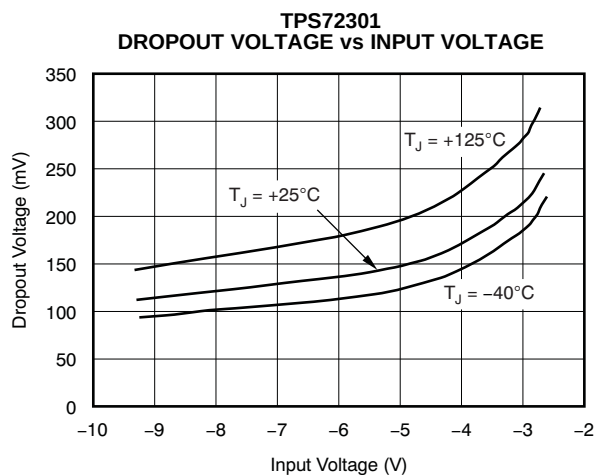


Figure 3.

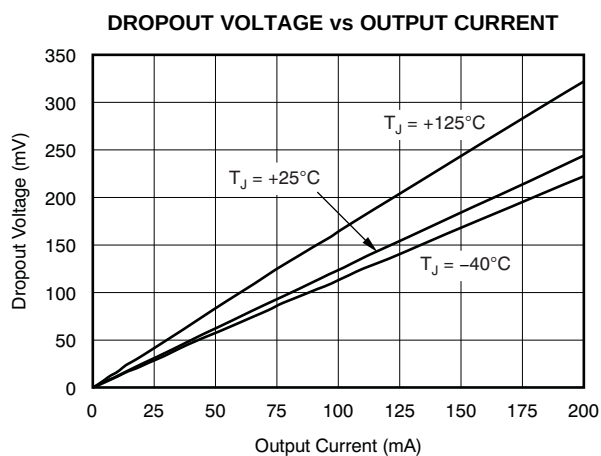


Figure 4.

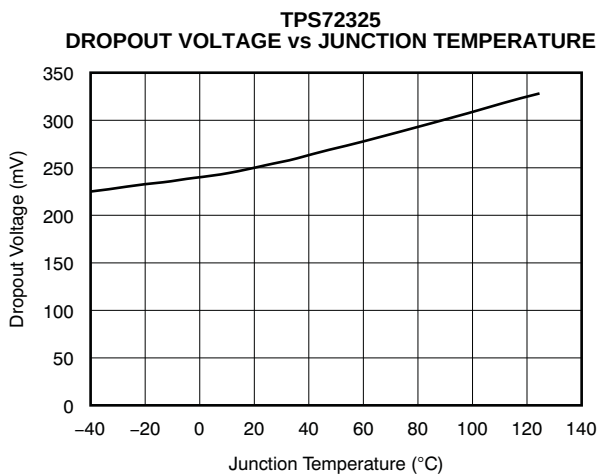


Figure 5.

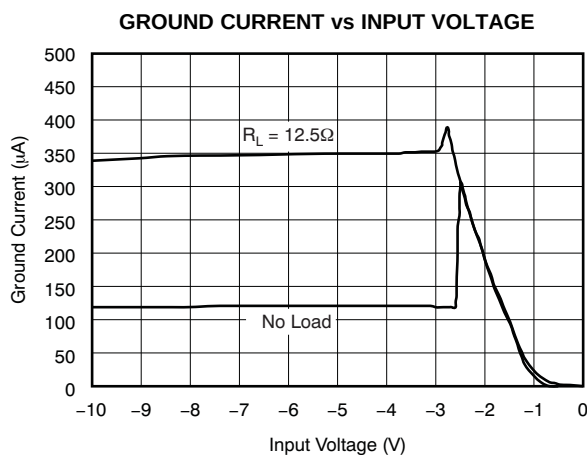


Figure 6.

## TYPICAL CHARACTERISTICS (continued)

TPS72325 at  $V_{IN} = V_{OUTnom} - 0.5V$ ,  $I_{OUT} = 1mA$ ,  $V_{EN} = 1.5V$ ,  $C_{OUT} = 2.2\mu F$ , and  $C_{NR} = 0.01\mu F$ , unless otherwise noted.

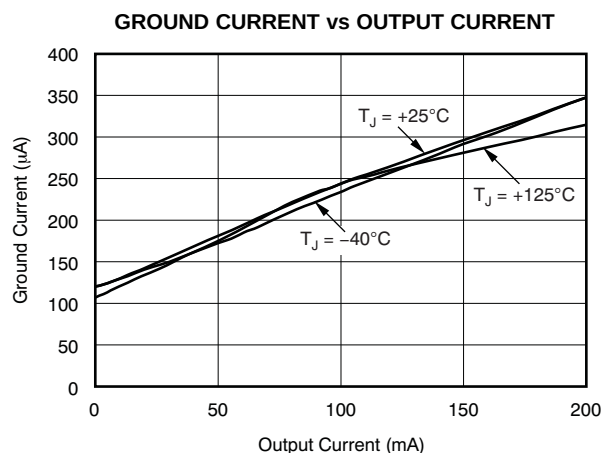


Figure 7.

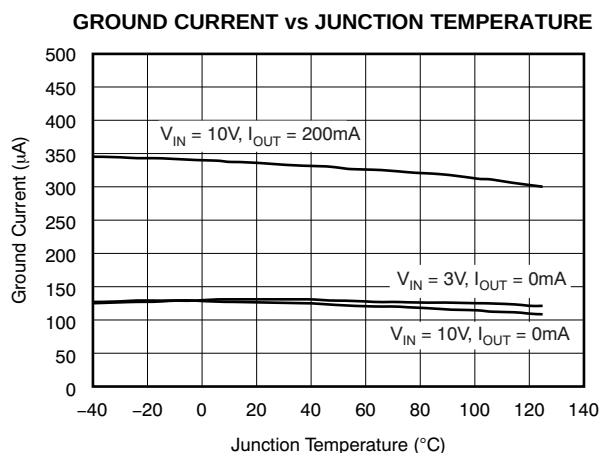


Figure 8.

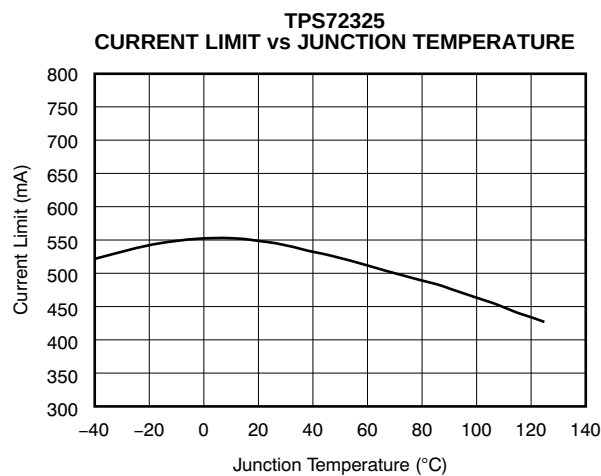


Figure 9.

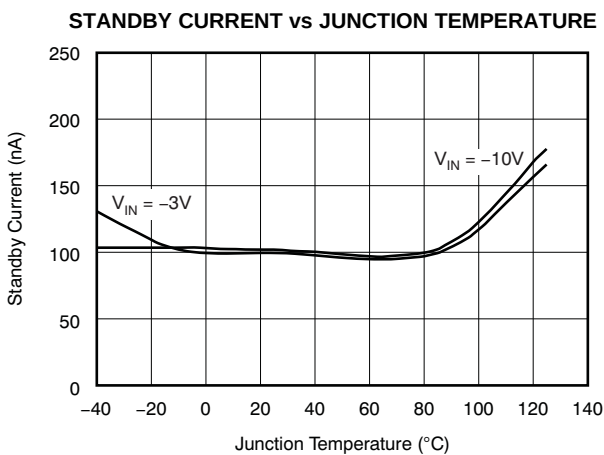


Figure 10.

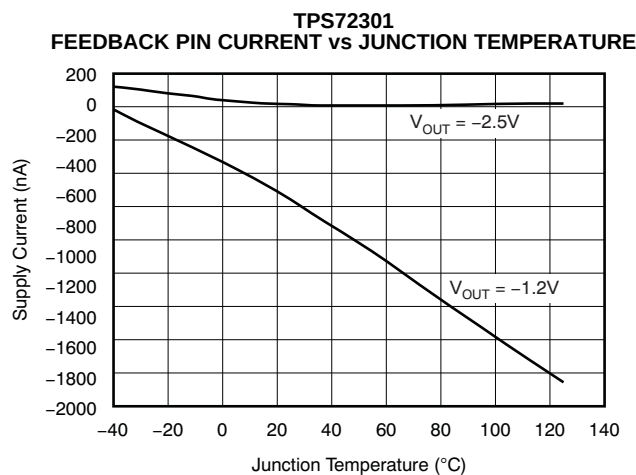


Figure 11.

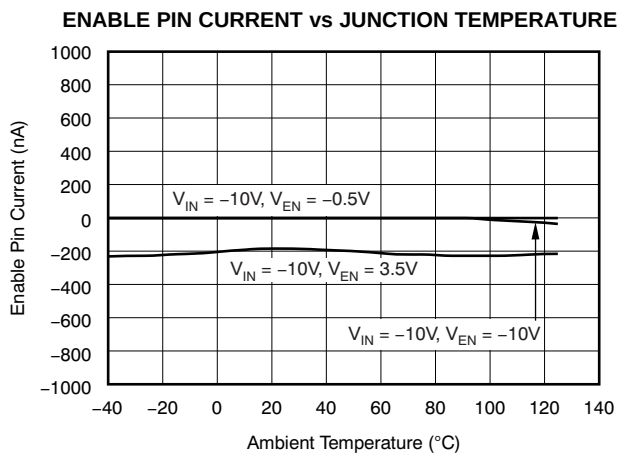


Figure 12.

## TYPICAL CHARACTERISTICS (continued)

TPS72325 at  $V_{IN} = V_{OUTnom} - 0.5V$ ,  $I_{OUT} = 1mA$ ,  $V_{EN} = 1.5V$ ,  $C_{OUT} = 2.2\mu F$ , and  $C_{NR} = 0.01\mu F$ , unless otherwise noted.

**LINE AND LOAD REGULATION  
vs JUNCTION TEMPERATURE**

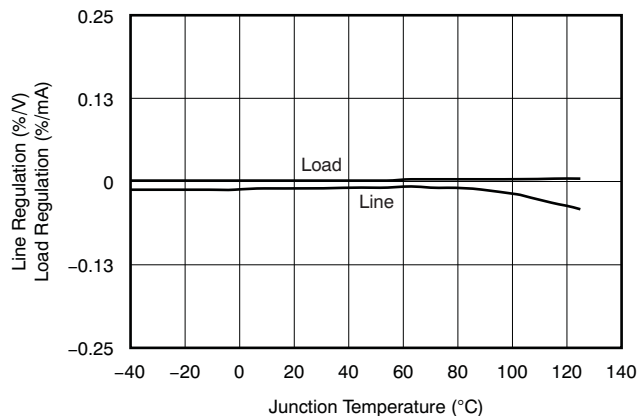


Figure 13.

**TPS72301  
MINIMUM REQUIRED INPUT VOLTAGE  
vs OUTPUT VOLTAGE**

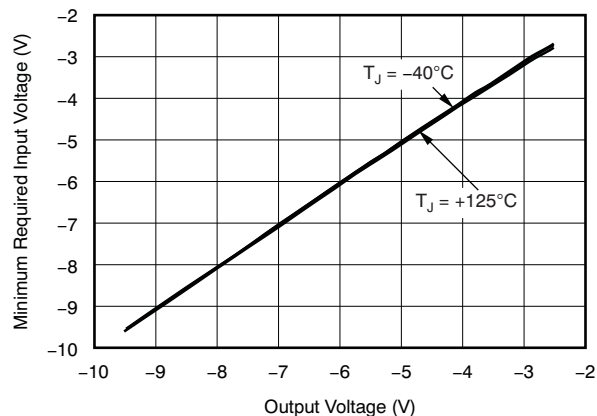


Figure 14.

**TPS72325  
LINE TRANSIENT RESPONSE**

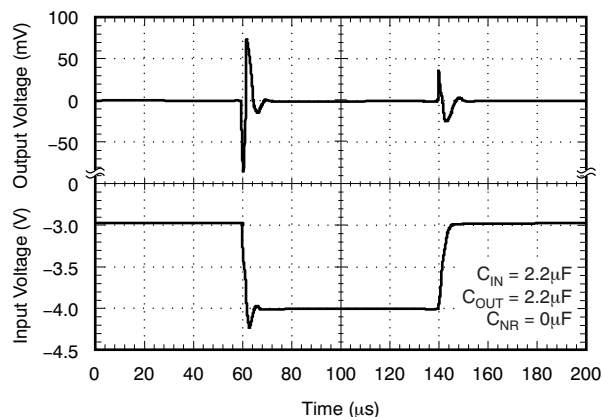


Figure 15.

**TPS72325  
LOAD TRANSIENT RESPONSE**

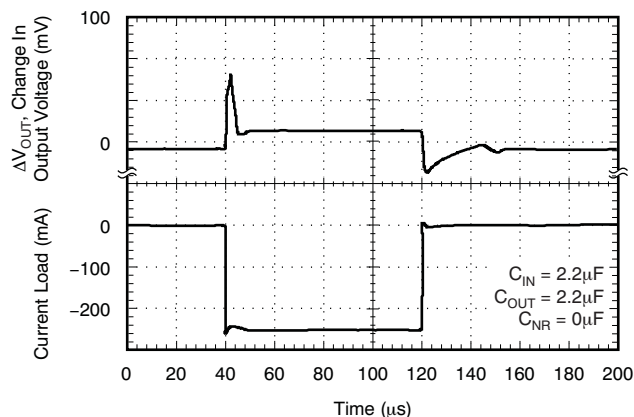


Figure 16.

**TPS72325  
LOAD TRANSIENT RESPONSE**

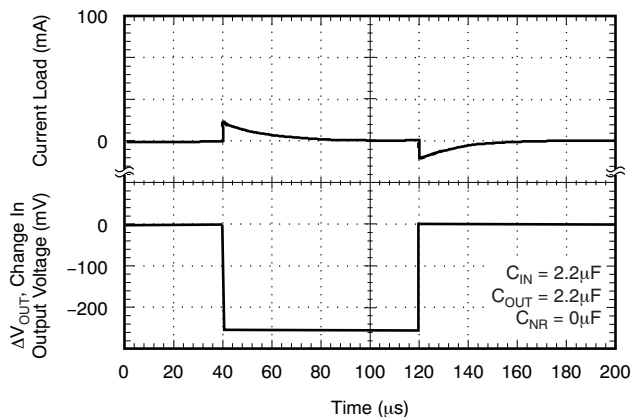


Figure 17.

**TPS72325  
START-UP RESPONSE**

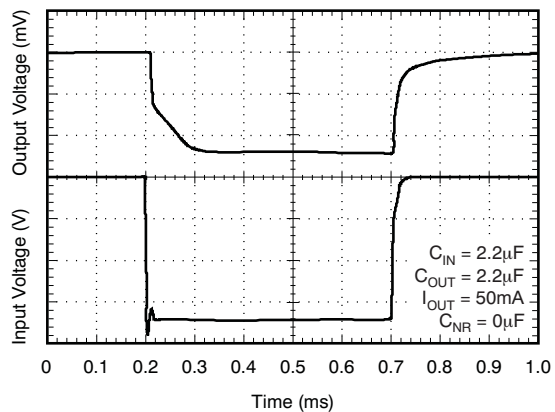


Figure 18.

## TYPICAL CHARACTERISTICS (continued)

TPS72325 at  $V_{IN} = V_{OUTnom} - 0.5V$ ,  $I_{OUT} = 1mA$ ,  $V_{EN} = 1.5V$ ,  $C_{OUT} = 2.2\mu F$ , and  $C_{NR} = 0.01\mu F$ , unless otherwise noted.

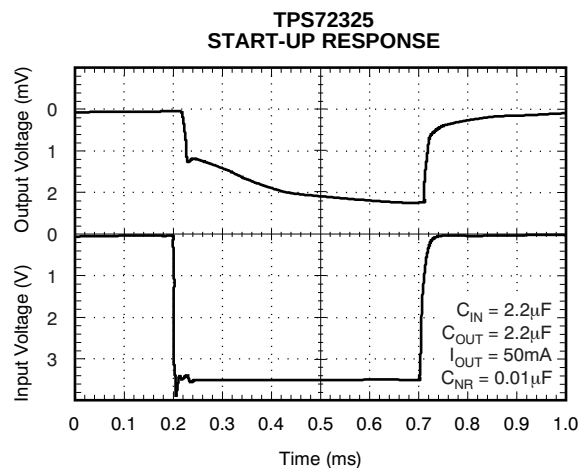


Figure 19.

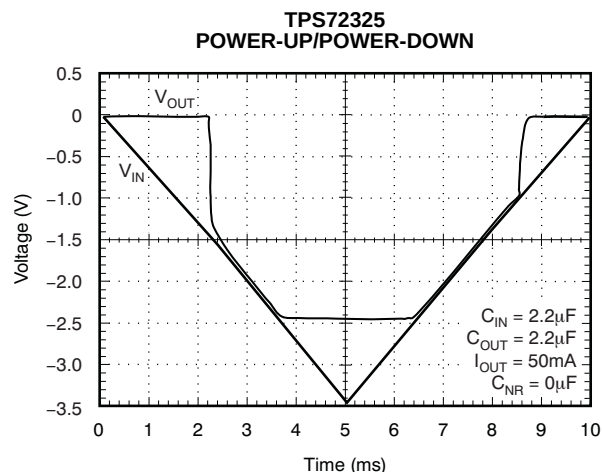


Figure 20.

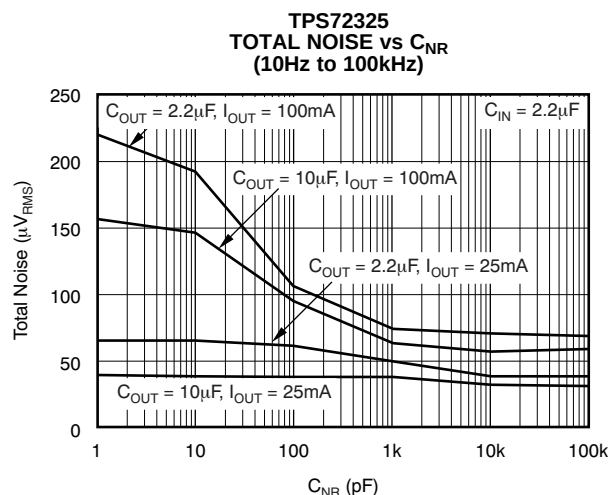


Figure 21.

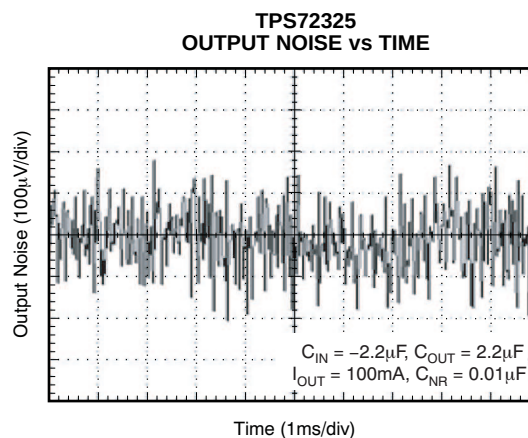


Figure 22.

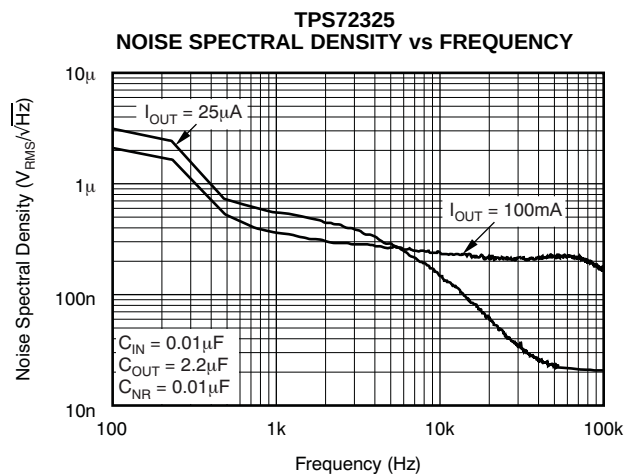


Figure 23.

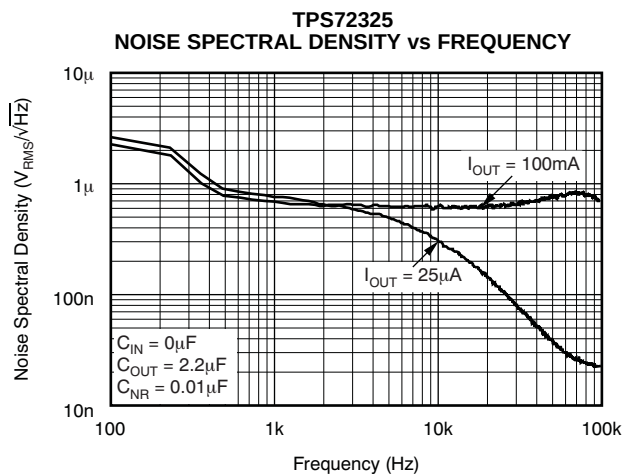


Figure 24.

## TYPICAL CHARACTERISTICS (continued)

TPS72325 at  $V_{IN} = V_{OUTnom} - 0.5V$ ,  $I_{OUT} = 1mA$ ,  $V_{EN} = 1.5V$ ,  $C_{OUT} = 2.2\mu F$ , and  $C_{NR} = 0.01\mu F$ , unless otherwise noted.

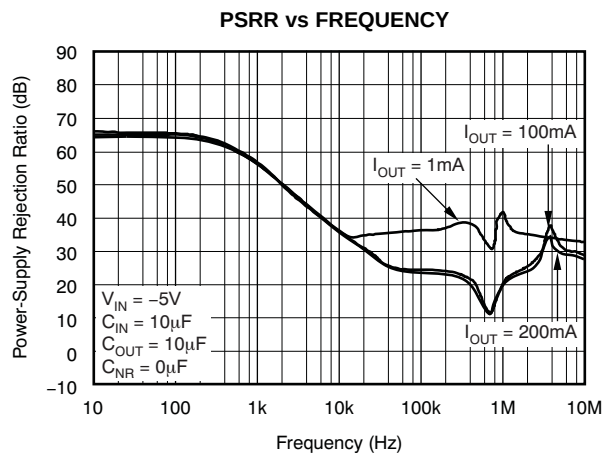


Figure 25.

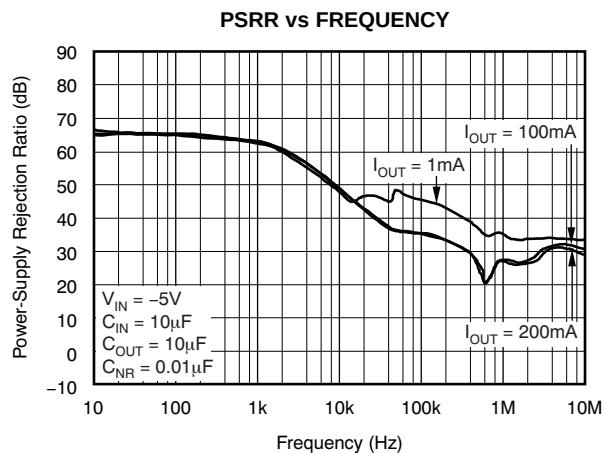


Figure 26.

## APPLICATION INFORMATION

### DEVICE OPERATION

The TPS723xx is a low-dropout negative linear voltage regulator with a rated current of 200mA. It is offered in trimmed output voltages between –1.5V and –5.2V and as an adjustable regulator from –1.2V to –10V. It features very low noise and high power-supply rejection ratio (PSRR), making it ideal for high-sensitivity analog and RF applications. A shutdown mode is available, reducing ground current to 2μA maximum over temperature and process. The TPS723xx is offered in a small SOT23 package and is specified over a –40°C to +125°C junction temperature range.

### ENABLE

The enable pin is active above +1.5V and below –1.5V, allowing it to be controlled by a standard TTL signal or by connection to  $V_I$  if not used. When driven to GND most internal circuitry is turned off, putting the TPS723xx into shutdown mode, drawing 2μA maximum ground current.

### ADJUSTABLE VOLTAGE APPLICATIONS

The TPS72301 allows designers to specify any output voltage from –10V to –1.2V. As shown in the application circuit in [Figure 27](#), an external resistor divider is used to scale the output voltage ( $V_{OUT}$ ) to the reference voltage. For best accuracy, use precision resistors for R1 and R2. Use the equations in [Figure 27](#) to determine the values for the resistor divider.

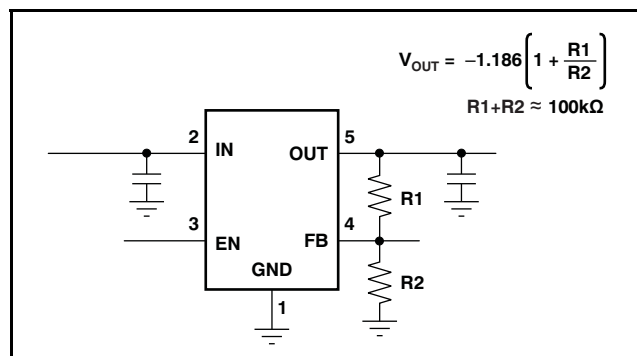


Figure 27. TPS72301 Adjustable LDO Regulator Programming

### CAPACITOR SELECTION FOR STABILITY

Appropriate input and output capacitors should be used for the intended application. The TPS723xx only requires a 2.2μF ceramic output capacitor to be

used for stable operation. Both the capacitor value and ESR affect stability, output noise, PSRR, and transient response. For typical applications, a 2.2μF ceramic output capacitor located close to the regulator is sufficient.

### OUTPUT NOISE

Without external bypassing, output noise of the TPS723xx from 10Hz to 100kHz is 200μV<sub>RMS</sub> typical. The dominant contributor to output noise is the internal bandgap reference. Adding an external 0.01μF capacitor to ground reduces noise to 60μV<sub>RMS</sub>. Best noise performance is achieved using appropriate low ESR capacitors for bypassing noise at the NR and OUT pins. See [Figure 21](#) in the [Typical Characteristics](#) section.

### POWER-SUPPLY REJECTION

The TPS723xx offers a very high PSRR for applications with noisy input sources or highly sensitive output supply lines. For best PSRR, use high-quality input and output capacitors.

### CURRENT LIMIT

The TPS723xx has internal circuitry that monitors and limits output current to protect the regulator from damage under all load conditions. When output current reaches the output current limit (550mA typical), protection circuitry turns on, reducing output voltage to ensure that current does not increase. See [Figure 9](#) in the [Typical Characteristics](#) section.

Do not drive the output more than 0.3V above the input. Doing so will bias the body diode in the pass FET, allowing current to flow from the output to the input. This current is not limited by the device. If this condition is expected, care should be taken to externally limit the reverse current.

### THERMAL PROTECTION

As protection from damage due to excessive junction temperatures, the TPS723xx has internal protection circuitry. When junction temperature reaches approximately +165°C, the output device is turned off. After the device has cooled by about 20°C, the output device is enabled, allowing normal operation. For reliable operation, design is for worst-case junction temperature of ≤ +125°C taking into account worst-case ambient temperature and load conditions.

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|--------------------|------|-------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| TPS72301DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | T08I                     | <a href="#">Samples</a> |
| TPS72301DBVRG4   | ACTIVE        | SOT-23       | DBV                | 5    | 3000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | T08I                     | <a href="#">Samples</a> |
| TPS72301DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | T08I                     | <a href="#">Samples</a> |
| TPS72301DBVTG4   | ACTIVE        | SOT-23       | DBV                | 5    | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | T08I                     | <a href="#">Samples</a> |
| TPS72325DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | T02I                     | <a href="#">Samples</a> |
| TPS72325DBVRG4   | ACTIVE        | SOT-23       | DBV                | 5    | 3000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | T02I                     | <a href="#">Samples</a> |
| TPS72325DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | T02I                     | <a href="#">Samples</a> |
| TPS72325DBVTG4   | ACTIVE        | SOT-23       | DBV                | 5    | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -40 to 125   | T02I                     | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> Only one of markings shown within the brackets will appear on the physical device.

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**OTHER QUALIFIED VERSIONS OF TPS72301, TPS72325 :**

- Automotive: [TPS72301-Q1](#), [TPS72325-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS72301DBVR | SOT-23       | DBV             | 5    | 3000 | 179.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS72301DBVT | SOT-23       | DBV             | 5    | 250  | 179.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS72325DBVR | SOT-23       | DBV             | 5    | 3000 | 179.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS72325DBVT | SOT-23       | DBV             | 5    | 250  | 179.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS

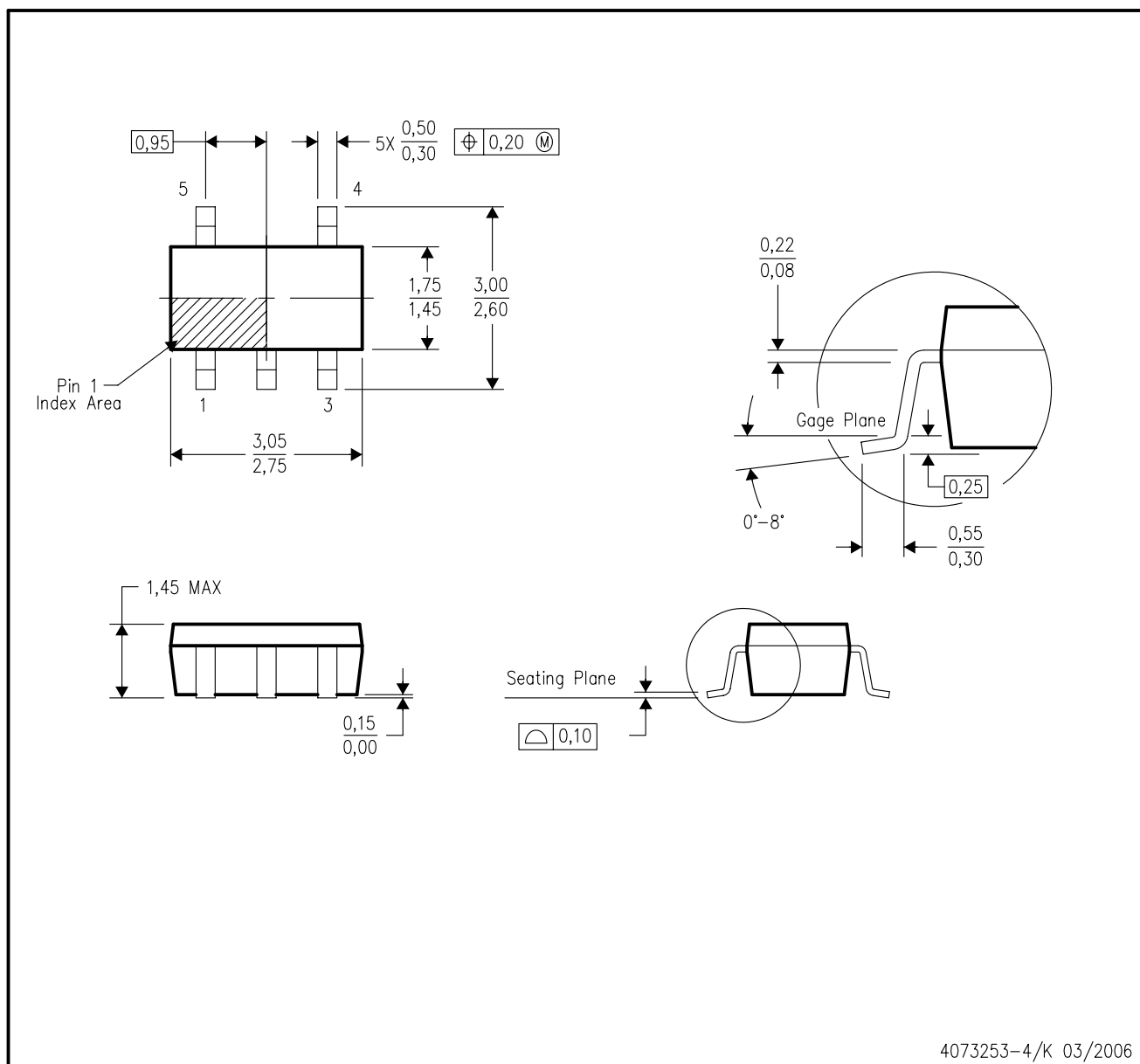


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS72301DBVR | SOT-23       | DBV             | 5    | 3000 | 203.0       | 203.0      | 35.0        |
| TPS72301DBVT | SOT-23       | DBV             | 5    | 250  | 203.0       | 203.0      | 35.0        |
| TPS72325DBVR | SOT-23       | DBV             | 5    | 3000 | 203.0       | 203.0      | 35.0        |
| TPS72325DBVT | SOT-23       | DBV             | 5    | 250  | 203.0       | 203.0      | 35.0        |

## DBV (R-PDSO-G5)

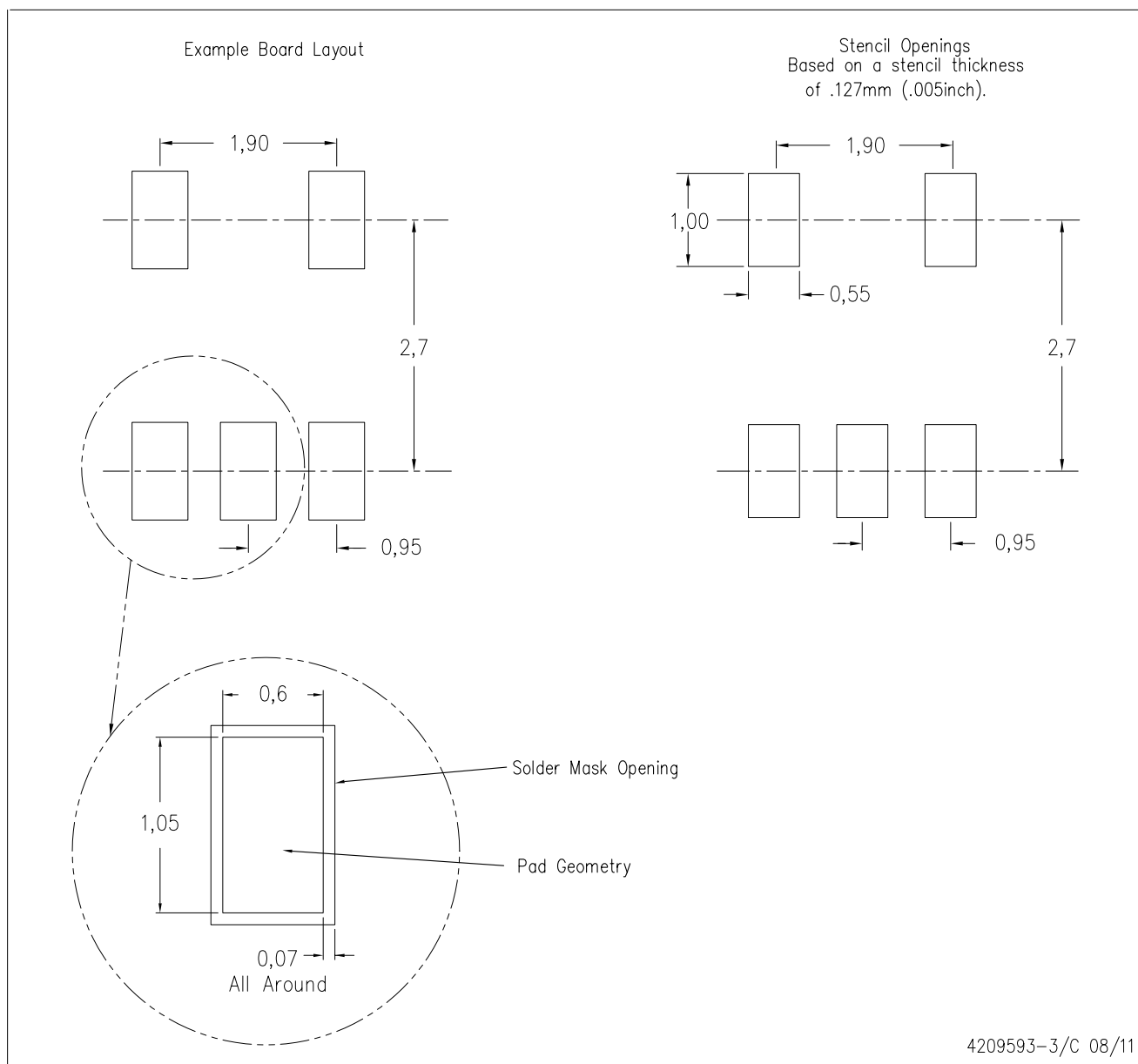
## PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - Falls within JEDEC MO-178 Variation AA.

DBV (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

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### Applications

|                               |                                                                                          |
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